

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT5263976

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
PRATIK M. KAMDAR	03/05/2018
JINCHENG WU	03/14/2018
JOEL A. CLARK	03/14/2018
MALAY GUPTA	03/05/2018
PLAMEN A. IVANOV	03/05/2018
RECEIVING PARTY DATA	
Name:	MOTOROLA MOBILITY LLC
Street Address:	222 WEST MERCHANDISE MART PLAZA
Internal Address:	SUITE 1800
City:	CHICAGO
State/Country:	ILLINOIS
Postal Code:	60654
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16208451
CORRESPONDENCE DATA	
Fax Number:	(512)617-5527
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	512-617-5525
Email:	patents@yudellisidore.com
Correspondent Name:	YUDELL ISIDORE PLLC
Address Line 1:	5145 RR 620N, STE F110
Address Line 4:	AUSTIN, TEXAS 78732
ATTORNEY DOCKET NUMBER:	MM920170125-US-DIV
NAME OF SUBMITTER:	EUSTACE P. ISIDORE
SIGNATURE:	/Eustace P. Isidore/
DATE SIGNED:	12/03/2018
Total Attachments: 5	

source=MM920170125-US-DIV_Assignment#page1.tif
source=MM920170125-US-DIV_Assignment#page2.tif
source=MM920170125-US-DIV_Assignment#page3.tif
source=MM920170125-US-DIV_Assignment#page4.tif
source=MM920170125-US-DIV_Assignment#page5.tif

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, we, **Pratik M. Kamdar, Naperville, Illinois; Jincheng Wu, Naperville, Illinois; Joel A. Clark, Woodridge, Illinois; Malay Gupta, South Elgin, Illinois; and Plamen A. Ivanov, Schaumburg, Illinois;** have sold, assigned and transferred, and do hereby sell, assign and transfer, unto MOTOROLA MOBILITY LLC, a Limited Liability Company of the State of Delaware, having its principal office in Chicago, State of Illinois, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions described, illustrated and claimed in the following applications:

U.S. Application filed herein and entitled: **"ECHO CANCELLATION AND SUPPRESSION IN ELECTRONIC DEVICE"**

U.S. Provisional Application No. **62/574,187**, filed on **October 18, 2017** entitled **"ECHO CANCELLATION AND SUPPRESSION IN ELECTRONIC DEVICE"**.

I hereby also sell, assign and transfer unto Assignee, the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and I further authorize Assignee to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby also sell, assign and transfer unto Assignee, the entire right, title and interest in and to other applications for Letters Patent on the inventions referenced in this Assignment and Agreement, and all rights, title and interest in and to all applications for Letters Patent in respect of the invention filed under any and all international conventions and treaties together with the entire right, title and interest in and to Letters Patent which may be issued upon the application(s) or any application(s) otherwise claiming priority thereto, and upon any divisions, extensions, continuations, reissues and/or re-examinations of such application(s).

I further authorize Assignee to apply for Letters Patent directly in its own name where applicable, and to claim priority of the filing date of the application for Letters

Patent filed under the laws of the applicable country and under the provisions of any and all international conventions and treaties.

I hereby authorize Assignee to request the Commissioner of Patents of the United States of America to issue any Letters Patents upon the aforesaid application, divisions, extensions, continuations, reissues or re-examinations, to Assignee, for the sole use and benefit of Assignee, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize Assignee to request the equivalent authorities in foreign countries to issue the patents of their respective countries to Assignee.

I agree that, when requested, I will, without charge to Assignee, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing, maintaining and enforcing patents for the inventions in any and all countries and for vesting title thereto in Assignee.

I covenant with Assignee that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

(1) Legal Name of Inventor: **Pratik M. Kamdar**

Signature:  Date: MAR 5th, 2018

(2) Legal Name of Inventor: **Jincheng Wu**

Signature: _____ Date: _____

(3) Legal Name of Inventor: **Joel A. Clark**

Signature: _____ Date: _____

Patent filed under the laws of the applicable country and under the provisions of any and all international conventions and treaties.

I hereby authorize Assignee to request the Commissioner of Patents of the United States of America to issue any Letters Patents upon the aforesaid application, divisions, extensions, continuations, reissues or re-examinations, to Assignee, for the sole use and benefit of Assignee, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize Assignee to request the equivalent authorities in foreign countries to issue the patents of their respective countries to Assignee.

I agree that, when requested, I will, without charge to Assignee, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing, maintaining and enforcing patents for the inventions in any and all countries and for vesting title thereto in Assignee.

I covenant with Assignee that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

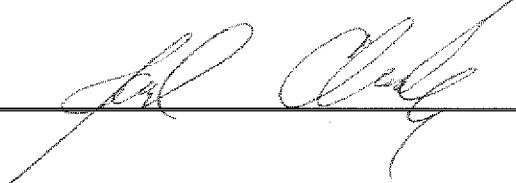
(1) Legal Name of Inventor: **Pratik M. Kamdar**

Signature: _____ Date: _____

(2) Legal Name of Inventor: **Jincheng Wu**

Signature:  Date: 03/14/2018

(3) Legal Name of Inventor: **Joel A. Clark**

Signature:  Date: 3/14/2018

(4) Legal Name of Inventor: **Malay Gupta**

Signature: Malay Gupta Date: 03/05/2018

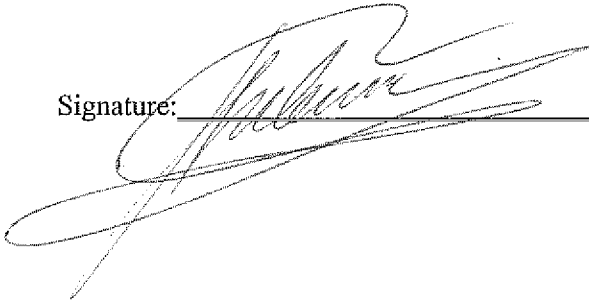
(5) Legal Name of Inventor: **Plamen A. Ivanov**

Signature: _____ Date: _____

(4) Legal Name of Inventor: **Malay Gupta**

Signature: _____ Date: _____

(5) Legal Name of Inventor: **Plamen A. Ivanov**

Signature:  _____ Date: 3/5/2018